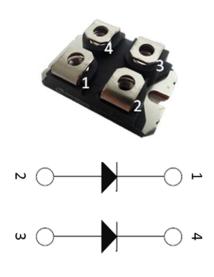


SiC SBD Parallel

Power Module



Parallel



$V_{RRM} = 600V$ $I_{DAV} = 10A @T_C = 125^{0}C$

Features

• SiC Schottky Diode

- Zero reverse recovery
- Zero forward recovery
- Temperature Independent switching behavior
- Positive temperature coefficient on V_F
- Low stray inductance
- High junction temperature operation

Applications

- Supplies for DC power equipment
- Rectifier for induction heating
- Welding equipment
- High temperature and rectifiers

Benefits

- Outstanding performance at high frequency operation
- Low losses and Low EMI noises
- Very rugged and easy mount
- Direct mounting to heatsink (isolated package)
- Low junction to case thermal resistance
- \bullet Easy paralleling due to positive $T_C\, of\, V_F$
- RoHS Compliant

Absolute Maximum Ratings (T_i=25°C unless otherwise specified)

Parameters	Symbol	Conditions	Specifications	Units
Maximum Reverse Voltage	V _{RRM}		600	V
Average Forward Current (per leg)	I _{DAV}	$T_{\rm C} = 25{}^{\rm 0}{\rm C}$	24	Α
		$T_{\rm C} = 125{}^{\rm 0}{\rm C}$	12	Α
Non-repetitive Forward Surge Current	I _{FSM}	tp=10 ms, $T_C = 25$ °C	96	Α
		tp=10 μ s, $T_C = 25$ $^{\circ}$ C	240	Α
Operating Junction Temperature	T _j		-55 ~ 175	°C
Storage Temperature	T _{STG}		-55 ~ 150	°C

Page 1 of 5 Rev. 1.2 01/03/2020



Electrical Characteristics (T_i=25°C unless otherwise specified)

Parameters	Symbol	Conditions	Min	Тур	Max	Units
Maximum peak repetitive reverse voltage	V _{RRM}		600			V
Maximum Reverse Leakage Current	I _{RM}	$V_R = 600V, T_j = 25$ °C		1.3	100	μΑ
per diode		$V_R = 600V, T_j = 150$ °C		485		μΑ
Diode Forward Voltage	V _F	$I_F = 10A, T_j = 25$ $^{\circ}C$		1.5	1.7	V
		$I_F = 10A, T_j = 75$ $^{\circ}C$		2.5	2.8	V
Total Capacitive Charge	Q _C	V _R =600 V, I _F <i<sub>F,max</i<sub>		25		nC
Switching Time	t _C	$dI_F/dt = 200 A/\mu s$, $T_j = 175 {}^{0}C$			10	ns
Total Capacitance	С	V _R = 1V, f = 1 MHz		487		pF
		V _R = 300V, f = 1 MHz		43		pF
		V _R = 600V, f = 1 MHz		41		pF

Thermal and Package Characteristics (T_j=25°C unless otherwise specified)

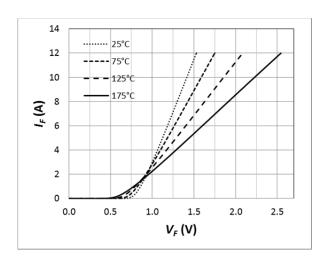
Parameters	Symbol	Conditions	Min	Тур	Max	Units
Junction to Case Thermal Resistance	R _{THJC}	Per Diode			1.54	°C /W
Junction to Ambient Thermal Resistance	R _{THJA}	Per Diode			20	°C /W
Mounting Torque	M _d				1.5	N-m
Terminal Connection Torque	M _{dt}		1.3		1.5	N-m
Package Weight	W _t			32		g
Isolation Voltage	V _{ISOL}	I _{ISOL} < 1mA, 50/60Hz, t=1 min	2500	V		

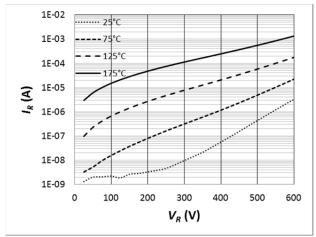
Product Number and Pin Descriptions

Part Number	Rating	Pin 1	Pin 2	Pin 3	Pin 4
GHXS010A060S-D3	600V, 10A	Cathode 1	Anode 1	Anode 2	Cathode 2

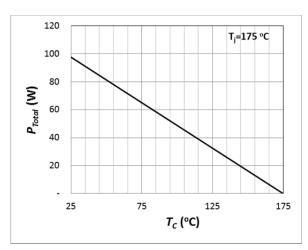
Page 2 of 5 Rev. 1.2 01/03/2020



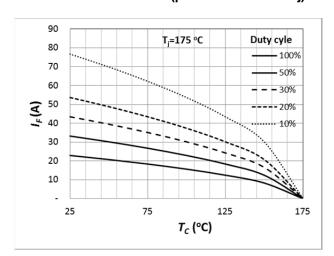




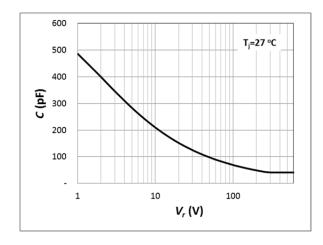
Forward Characteristics (parameterized on Tj)



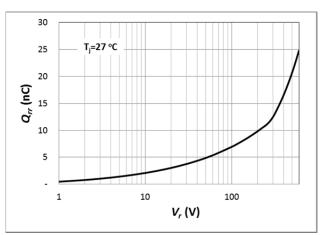
Reverse Characteristics (parameterized on Tj)



Power Derating



Current Derating



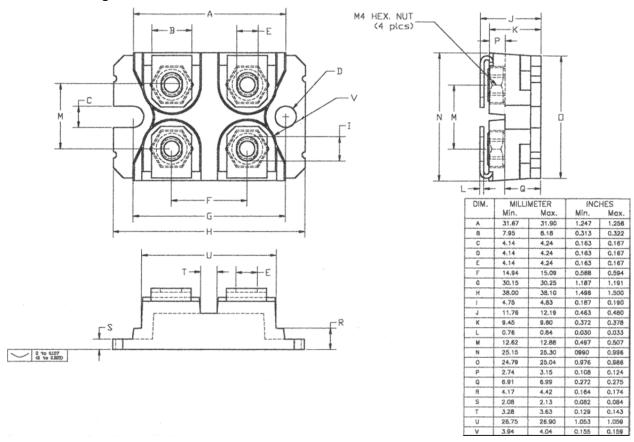
Capacitance Curve

Recovery Charge

Page 3 of 5 Rev. 1.2 01/03/2020



SOT-227 Package Outline



Page 4 of 5 Rev. 1.2 01/03/2020



Revision History

Date	Revision	Notes
9/6/2011	1.0	Initial release
6/4/2014	1.1	Add the part number, pin assignment table.
01/03/2020	1.2	Applied company name change

Notes

RoHS Compliance

The levels of RoHS restricted materials in this product are below the maximum concentration values (also referred to as the threshold limits) permitted for such substances, or are used in an exempted application, in accordance with EU Directive 2011/65/EC (RoHS2), as implemented March, 2013. RoHS Declarations for this product can be obtained from the Product Documentation sections of www.SemiQ.com.

REACh Compliance

REACh substances of high concern (SVHC) information is available for this product. Since the European Chemicals Agency (ECHA) has published notice of their intent to frequently revise the SVHC listing for the foreseeable future, please contact our office at SemiQ Headquarters in Lake Forest, California to insure you get the most up-to-date REACh SVHC Declaration. REACh banned substance information (REACh Article 67) is also available upon request.

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Page 5 of 5 Rev. 1.2 01/03/2020

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